

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT3919373

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
SATOSHI INOUE	05/30/2016
TATSUYA SHIMODA	05/30/2016
NOBUTAKA FUJIMOTO	05/20/2016
KIYOSHI NISHIOKA	05/23/2016
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**PROPERTY NUMBERS Total: 1**

Property Type	Number
<b>Application Number:</b>	15104726

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<b>ATTORNEY DOCKET NUMBER:</b>	KSSC14P003US (J02.001)
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<b>DATE SIGNED:</b>	06/15/2016
<b>Total Attachments: 3</b> source=KSSC14P003US (J02.001) - Executed Assignment of Rights#page1.tif source=KSSC14P003US (J02.001) - Executed Assignment of Rights#page2.tif source=KSSC14P003US (J02.001) - Executed Assignment of Rights#page3.tif	

## ASSIGNMENT OF RIGHTS, TITLE AND INTEREST IN INVENTION

This is an Assignment of the following rights, title and interest: *(check all that apply)*

- United States of America rights, title and interest in the invention
- Foreign rights, title and interest in the invention
- The following United States Patent Application  
United States Patent Application No.: 15/104,726  
which was filed on: June 15, 2016
- United States Provisional Patent Application Serial No.:
- United States Patent No(s):
- International (PCT) Patent Application Serial No.: PCT/JP2014/083187
- Other (*specify*): JP Application No. 2013-259031 -- filed 16 December 2013

### TITLE OF THE INVENTION:

**SEMICONDUCTOR DEVICE, METHOD FOR PRODUCING SAME AND ALIPHATIC POLYCARBONATE**

### Inventors (*assignors*)

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Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified assignees;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignees;

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignees, as assignees of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters

Patent which may be granted for my aforesaid Invention, as the Assignees or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures

May 30, 2016  
Date

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Satoshi INOUE

May 30, 2016  
Date

Tatsuya Shimoda  
Tatsuya SHIMODA

May 20, 2016  
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Nobutaka Fujimoto  
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Kiyoshi Nishioka  
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Shuichi Karashima  
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